

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6143973

| | |
|---|--|
| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| KATHERINE H. CHIANG | 05/24/2019 |
| CHUNG-TE LIN | 06/03/2019 |
| MIN CAO | 06/06/2019 |
| HAN-TING TSAI | 05/24/2018 |
| PIN-CHENG HSU | 05/24/2019 |
| YEN-CHUNG HO | 05/24/2019 |
| RECEIVING PARTY DATA | |
| Name: | TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. |
| Street Address: | NO. 8, LI-HSIN RD. 6 |
| Internal Address: | HSIN-CHU SCIENCE PARK |
| City: | HSIN-CHU |
| State/Country: | TAIWAN |
| Postal Code: | 300-77 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 16896369 |
| CORRESPONDENCE DATA | |
| Fax Number: | (216)502-0601 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 216-502-0600 |
| Email: | docketing@eschweilerlaw.com |
| Correspondent Name: | ESCHWEILER & POTASHNIK, LLC |
| Address Line 1: | ROSETTA CENTER |
| Address Line 2: | 629 EUCLID AVE., SUITE 1000 |
| Address Line 4: | CLEVELAND, OHIO 44114 |
| ATTORNEY DOCKET NUMBER: | TSMCP943USA |
| NAME OF SUBMITTER: | JAMES R. POTASHNIK |
| SIGNATURE: | /James R. Potashnik/ |
| DATE SIGNED: | 06/09/2020 |

PATENT

Total Attachments: 8

source=Assignment#page1.tif

source=Assignment#page2.tif

source=Assignment#page3.tif

source=Assignment#page4.tif

source=Assignment#page5.tif

source=Assignment#page6.tif

source=Assignment#page7.tif

source=Assignment#page8.tif

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

Katherine H. Chiang

Assignor(s):

Chung-Te Lin

Assignor(s):

Min Cao

Assignor(s):

Han-Ting Tsai

Assignor(s):

Pin-Cheng Hsu

Assignor(s):

Yen-Chung Ho

Assignee:

Taiwan Semiconductor Manufacturing Co., Ltd.
No. 8, Li-Hsin Rd. 6, Hsin-Chu Science Park
Hsin-Chu, Taiwan 300-77
Republic of China

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled

"INTEGRATED SYSTEM CHIP WITH MAGNETIC MODULE" for which:

a non-provisional application for United States Letters Patent:

☒ was executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration); or

☐ was filed on _____ and accorded U.S. Serial No. _____; or

☐ I hereby authorize and request my attorney associated with Customer No. 107476, to insert on the designated lines below the filing date and application number of said application when known:

U.S. Serial No. _____

filed on _____

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

TSMC Docket No. P20180279US00
Docket No. TSMCP943US

2019.5.24
Date

Katherine Chiang
Name 1st Inventor Katherine H. Chiang

TSMC Docket No. P20180279US00
Docket No. TSMCP943US

6/3. 2019
Date

Lin Chung-Te
Name 2nd Inventor Chung-Te Lin

TSMC Docket No. P20180279US00
Docket No. TSMCP943US

6/6/2019
Date


Name 3rd Inventor Min Cao

TSMC Docket No. P20180279US00
Docket No. TSMCP943US

2018 / 5 / 24

Date

Name 4th Inventor Han-Ting Tsai

TSMC Docket No. P20180279US00
Docket No. TSMCP943US

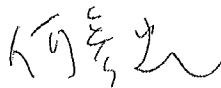
5/24/2019
Date

Pin-cheng Hsu 5/24/2019
Name 5th Inventor Pin-Cheng Hsu

TSMC Docket No. P20180279US00
Docket No. TSMCP943US

2019/5/24

Date



Yen-Chung Ho

Name 6th Inventor Yen-Chung Ho